## **DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

(Application Number)

My residence, post office addre I believe I am the original, first a inventor (if plural names are list on the invention entitled IMPRC hereto unless the following box	and sole inventor (if only ed below) of the subjec VED PREMOLDED CA	one name is listed below) or t matter which is claimed and	an original, first and joint for which a patent is sought
□ was filed on Application Number	as United Stat	es Application Number or PCT as amended on	「International (if applicable).
I hereby state that I have review claims, as amended by any ame			ed specification, including the
I acknowledge the duty to disclo	ose information which is	s material to patentability as de	efined in 37 CFR § 1.56.
I hereby claim foreign priority be patent or inventor's certificate, of country other than the United S or inventor's certificate, or PCT priority is claimed.	or § 365(a) of any PCT tates, listed below and	International application which have also identified below any	designated at least one foreign application for patent
Prior Foreign Application(s)		Priority Date	<b>Priority Claimed</b>
(Number)	(Country) (PCT)	(Day/Month/Year Filed	Yes No
Prior Foreign Application(s)		Priority Date	Priority Claimed
(Number)	(Country) (PCT)	(Day/Month/Year Filed	Yes No
I hereby claim the benefit unde	r 35 U.S.C. § 119(e) of	any United States provisional	application(s) listed below.
(Application Number)		(Filing Date)	
			·

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to

(Filing Date)

(Application Number)	(Filing Date)	(Status-patented, pending, abandoned)	
(Application Number)	(Filing Date)	(Status – patented, pending, abandoned)	
(Application Number)	(Filing Date)	(Status – patented, pending, abandoned)	
	ng attorney(s) and/or agent(s) k Office connected therewith:	to prosecute this application and to transact all busin	
Joseph R. Keating, Reg. No			
Address all correspondence	e to:  Joseph R. Keating, Esq.  Keating & Bennett LLP  10400 Eaton Place, Suite 312  Fairfax, VA 22030  (703) 385-5200		
information and belief are b that willful false statements	elieved to be true; and furthe and the like so made are pur d States Code and that such	wn knowledge are true and that all statements made rethat these statements were made with the knowledguishable by fine or imprisonment, or both, under Section willful false statements may jeopardize the validity of	
	given name, family name) <u>Lat</u>		
		Date Sept 16, 202	
Inventor's signature Residence Flat F, 14 <sup>th</sup> Floor	Themy r. Blk. 21, Riviera Garden, Ts		
Inventor's signature	Themy r. Blk. 21, Riviera Garden, Ts	Date Sept 16, 2002	
Inventor's signature  Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same	Themy r. Blk. 21, Riviera Garden, Ts	uen Wan, N.T. Hong Kong Citizenship Indian	
Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same in	r. Blk. 21. Riviera Garden, Ts as above	uen Wan, N.T. Hong Kong Citizenship Indian	
Inventor's signature  Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same inventorial signature  Inventor's signature	r. Blk. 21. Riviera Garden, Ts as above	Date Sept 16, 2002	
Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same :  Full name of second inventor inven	r. Blk. 21, Riviera Garden, Tsas above  or (given/name, family name)  h. Flat 3B, Mid Levels, Hong	Date Sept 16, 2002	
Residence Flat F. 14 <sup>th</sup> Floor Post Office Address Same Full name of second inventor Inventor's signature Residence 3 Tregunter Pat	r. Blk. 21, Riviera Garden, Tsas above  or (given/name, family name)  h. Flat 3B, Mid Levels, Hong	Date Sept 16, 2002	
Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same Full name of second inventor Inventor's signature Residence 3 Tregunter Pat Post Office Address Same	r. Blk. 21, Riviera Garden, Tsas above  or (given/name, family name)  h. Flat 3B, Mid Levels, Hong	Date Sept 16, 2002  Neil McLELLAN  Date Sept 16, 2002  Kong, Citizenship U.S.A.	
Residence Flat F, 14 <sup>th</sup> Floor Post Office Address Same Full name of second inventor Inventor's signature Residence 3 Tregunter Pat Post Office Address Same	r. Blk. 21, Riviera Garden, Tsas above  or (giver/name, family name)  h. Flat 3B, Mid Levels, Hong as above	Date Sept 16, 2002  Neil McLELLAN  Date Sept 16, 2002  Kong, Citizenship U.S.A.	

Post Office Address Same as above

Full name of third inventor (given name, family name) William Lap Keung Chow				
Inventor's signature				
Residence Flat D, 35/F, Tower 10, Park Avenue, Tai Kok Tsui, Hong Kong Citizenship Hong Kong				
Post Office Address Same as above				

•